

CORRECTION

View Article Online

View Journal | View Issue

Cite this: *Nanoscale*, 2018, **10**, 3068

Correction: 3D polymer objects with electronic components interconnected *via* conformally printed electrodes

Yejin Jo,^{a,b} Ju Young Kim,^a Sungmook Jung,^a Bok Yeop Ahn,^c Jennifer A. Lewis,^c Youngmin Choi^{*a,b} and Sunho Jeong^{*a,b}

DOI: 10.1039/c8nr90018c

rsc.li/nanoscale

Correction for '3D polymer objects with electronic components interconnected *via* conformally printed electrodes' by Yejin Jo, *et al.*, *Nanoscale*, 2017, **9**, 14798–14803.

(1) On page 14799, left column, the sentence beginning “The thermoplastic SIS tri-block copolymer...” contains an incorrect temperature value. The correct sentence should read “The thermoplastic SIS tri-block copolymer, which consists of isoprene segments with glass transition temperature below $-60\text{ }^{\circ}\text{C}$, promotes good adhesion properties to the underlying 3D polymer surfaces¹⁷ (Fig. S1†).

(2) In Fig. 1a of the published article, the chemical ratio $(x + z) : y = 22 : 88$ is incorrect. The correct ratio should be given as $(x + z) : y = 22 : 78$.

The Royal Society of Chemistry apologises for these errors and any consequent inconvenience to authors and readers.

^aDivision of Advanced Materials, Korea Research Institute of Chemical Technology (KRICT), 19 Sinseongno, Yuseong-gu, Daejeon 305-600, Korea.

E-mail: youngmin@kRICT.re.kr, sjeong@kRICT.re.kr

^bDepartment of Chemical Convergence Materials, Korea University of Science and Technology (UST), 217 Gajeongno, Yuseong-gu, Daejeon 305-350, Korea

^cWyss Institute for Biologically Inspired Engineering, John A. Paulson School of Engineering and Applied Sciences, Harvard University, Cambridge, MA 02138, USA

